

# DECLARATION FOR PATENT APPLICATION (WITH POWER OF ATTORNEY)

As an inventor named below or on any attached continuation page, I hereby declare that:  
My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled MULTI-FREQUENCY PLASMA REACTOR AND METHOD OF ETCHING, the specification of which (check one):

- ☒ is attached hereto.  
☐ was filed on \_\_\_\_\_ as United States application serial no. \_\_\_\_\_ and was amended on \_\_\_\_\_.  
☐ was filed on \_\_\_\_\_ as PCT international application no. \_\_\_\_\_ and was amended under PCT Article 19 on \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to the patentability of the subject matter claimed in this application, as "materiality" is defined in Title 37, Code of Federal Regulations § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT international application(s) designating at least one country other than the United States of America listed below and on any attached continuation page and have also identified below and on any attached continuation page any foreign application for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America having a filing date before that of the application(s) on which priority is claimed.

Prior foreign/PCT application(s):

|          |           |                        | Priority | Claimed |
|----------|-----------|------------------------|----------|---------|
| _____    | _____     | _____                  | _____    | _____   |
| (number) | (country) | (day/month/year filed) | Yes      | No      |
| _____    | _____     | _____                  | _____    | _____   |
| (number) | (country) | (day/month/year filed) | Yes      | No      |

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of PCT international application(s) designating the United States of America listed below and on any attached continuation page and, insofar as the subject matter of each of the claims of this application is not disclosed in any such prior application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available

**DECLARATION FOR PATENT APPLICATION**  
(continuation page)

Invention Title: MULTI-FREQUENCY PLASMA REACTOR AND METHOD OF ETCHING

between the filing date of such prior application and the national or PCT international filing date of this application:

|                          |               |   |
|--------------------------|---------------|---|
| _____                    | _____         | _____                                   |
| (application serial no.) | (filing date) | (status—pending, patented or abandoned) |
| _____                    | _____         | _____                                   |
| (application serial no.) | (filing date) | (status—pending, patented or abandoned) |

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:

|                               |               |
|-------------------------------|---------------|
| _____                         | _____         |
| (provisional application no.) | (filing date) |

I hereby appoint the following Registered Practitioners to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

|                                     |  |
|-------------------------------------|--|
| David V. Trask, Reg. No. 22,012     | William S. Britt, Reg. No. 20,969        |
| Laurence B. Bond, Reg. No. 30,549   | Joseph A. Walkowski, Reg. No. 28,765     |
| James R. Duzan, Reg. No. 28,393     | H. Dickson Burton, Reg. No. 48,396       |
| Allen C. Turner, Reg. No. 33,041    | Edgar R. Cataxinos, Reg. No. 39,931      |
| Kent S. Burningham, Reg. No. 30,453 | Brick G. Power, Reg. No. 38,581          |
| Kevin K. Johanson, Reg. No. 38,506  | Krista Weber Powell, Reg. No. 47,867     |
| Shawn G. Hansen, Reg. No. 42,627    | Bretton L. Crockett, Reg. No. 44,632     |
| Tawni L. Wilhelm, Reg. No. 47,456   | Bradley B. Jensen, Reg. No. 46,801       |
| Andrew F. Nilles, Reg. No. 47,825   | Greg T. Warder, Reg. No. 50,208          |
| Katherine A. Hamer, Reg. No. 47,628 | Marcus S. Simon, Reg. No. 50,258         |
| Trent N. Butcher, Reg. No. 51,518   | G. Scott Dorland, Ph.D., Reg. No. 51,622 |
| Michael L. Lynch, Reg. No. 30,871   | Charles B. Brantley II, Reg. No. 38,086  |

Address all correspondence to: Kevin K. Johanson, telephone no. (801) 532-1922.

**TRASKBRITT, PC**  
**P.O. Box 2550**  
**Salt Lake City, Utah 84110**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that

**DECLARATION FOR PATENT APPLICATION**  
(continuation page)

Invention Title: MULTI-FREQUENCY PLASMA REACTOR AND METHOD OF ETCHING

such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first joint inventor: Bradley J. Howard

Inventor's signature Bradley J. Howard Date July 11, 2003

Residence: Boise, Idaho

Citizenship: U.S.A.

Post Office Address: 5694 Schooner Way, Boise, Idaho 83716

Document in ProLaw

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bradley J. Howard  
 Serial No.: Not Yet Assigned  
 Filed:  
 Title: MULTI-FREQUENCY PLASMA REACTOR AND METHOD OF ETCHING

Examiner: Unknown  
 Group Art Unit: Unknown  
 Attorney Docket No.: 2269-5862US (02-1563.00/US)

POWER OF ATTORNEY BY ASSIGNEE  
AND CERTIFICATE UNDER 37 CFR § 3.73(b)

Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Sir:

MICRON TECHNOLOGY, INC., assignee of the entire right, title and interest by assignment from the inventor(s) in the above-identified application, hereby appoints the following attorneys and agents:

|  |                                      |   |
|--|--------------------------------------|---|
| David V. Trask, Reg. No. 22,012          | William S. Britt, Reg. No. 20,969    | Laurence B. Bond, Reg. No. 30,549       |
| Joseph A. Walkowski, Reg. No. 28,765     | James R. Duzan, Reg. No. 28,393      | H. Dickson Burton, Reg. No. 48,396      |
| Allen C. Turner, Reg. No. 33,041         | Edgar R. Cataxinos, Reg. No. 39,931  | Kent S. Burningham, Reg. No. 30,453     |
| Brick G. Power, Reg. No. 38,581          | Kevin K. Johanson, Reg. No. 38,506   | Krista Weber Powell, Reg. No. 47,867    |
| Shawn G. Hansen, Reg. No. 42,627         | Bretton L. Crockett, Reg. No. 44,632 | Tawni L. Wilhelm, Reg. No. 47,456       |
| Bradley B. Jensen, Reg. No. 46,801       | Andrew F. Nilles, Reg. No. 47,825    | Greg T. Warder, Reg. No. 50,208         |
| Katherine A. Hamer, Reg. No. 47,628      | Marcus S. Simon, Reg. No. 50,258     | Trent N. Butcher, Reg. No. 51,518       |
| G. Scott Dorland, Ph.D., Reg. No. 51,622 | Michael L. Lynch, Reg. No. 30,871    | Charles B. Brantley II, Reg. No. 38,086 |

as its attorneys with full power of substitution to prosecute this application and all applications claiming filing date priority therefrom and to transact all business in the U.S. Patent and Trademark Office in connection therewith.

The above-identified assignee hereby elects, pursuant to 37 C.F.R. § 3.71, to conduct the prosecution of the above-identified patent application to the exclusion of the inventor(s).

A chain of title from the inventor(s) of the above-identified patent application to the above-identified assignee is shown:

- ☐ In an assignment recorded in the U.S. Patent and Trademark Office at Reel \_\_\_\_\_, Frame \_\_\_\_\_.
- ☒ In an assignment filed herewith for recordation, a true copy of which is attached hereto.

The undersigned has reviewed the above-identified assignment and, to the best of his knowledge and belief, title is in the above-identified assignee.

The undersigned further avers that he is empowered to make and sign the foregoing certification on behalf of the above-identified assignee, and to take the action set forth herein on its behalf.

Please direct all communications regarding the above-identified application to:

Kevin K. Johanson,  
 TRASKBRITT  
 P.O. Box 2550  
 Salt Lake City, UT 84110  
 Telephone: (801) 532-1922  
 Fax: (801) 531-9168

Respectfully submitted,

MICRON TECHNOLOGY, INC.

Date: 7-17-07

By: [Signature]  
 Michael L. Lynch, Esq.  
 Reg. No. 30,871  
 Chief Patent Counsel,  
 MICRON TECHNOLOGY, INC.